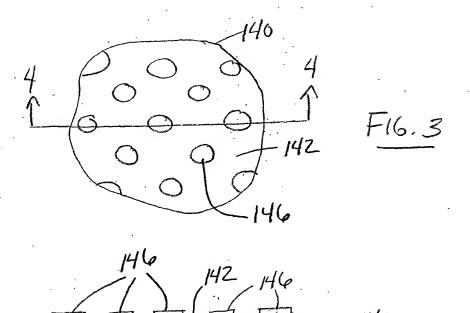
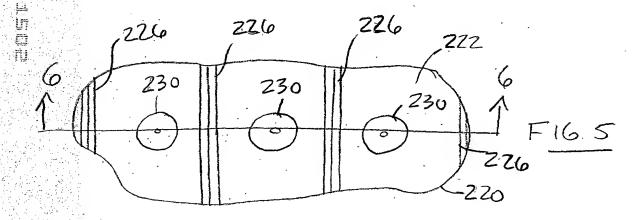
Applicant(s): Serial No.: Unassigned Express Mail No.: EL888274233US

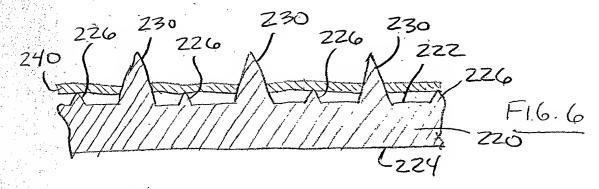
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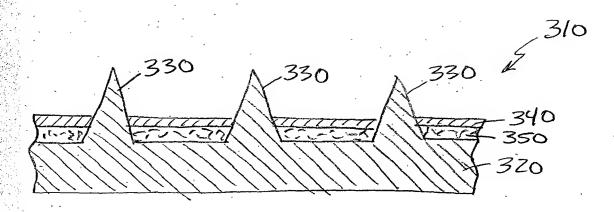




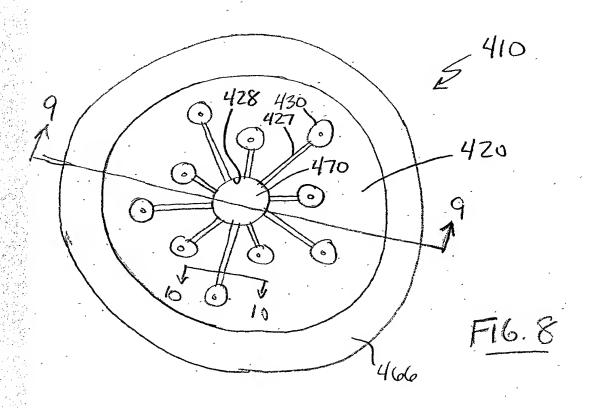


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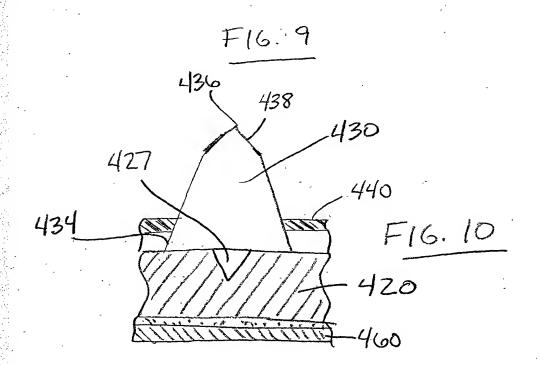


F16.7



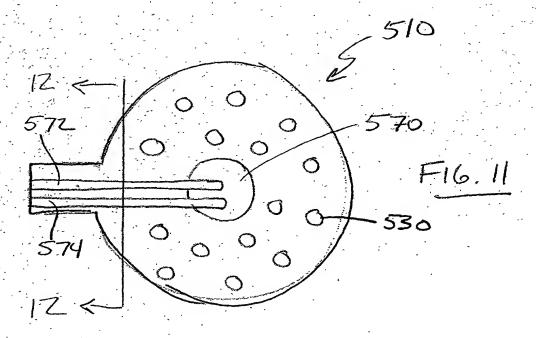
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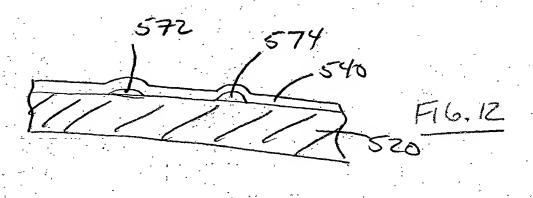
464 466 466



Title: MICRONEEDLE DEVICES AND METHODS OF MANUFACTURE
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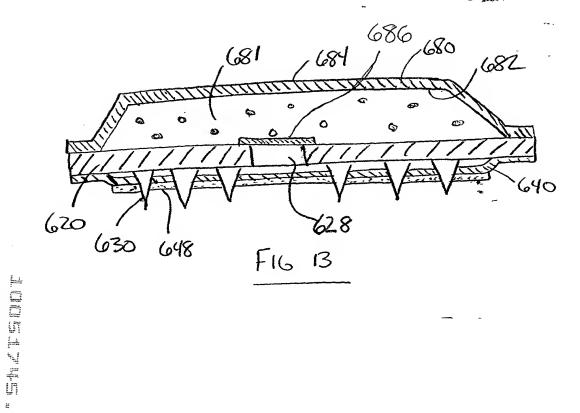


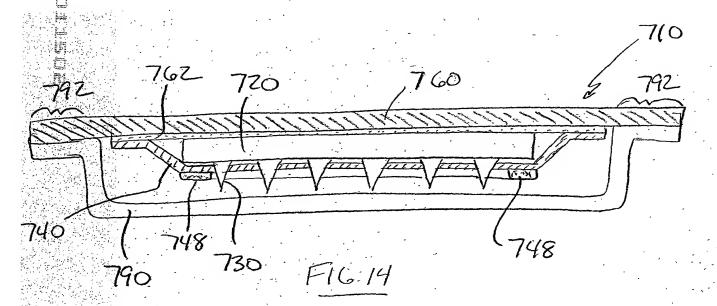
Title: MICRONEEDLE DEVICES AND METHODS OF MANUFACTURE Applicant(s):

Serial No.: Unassigned Filed: Herewith Docket: Express Mail No.: EL888274233US

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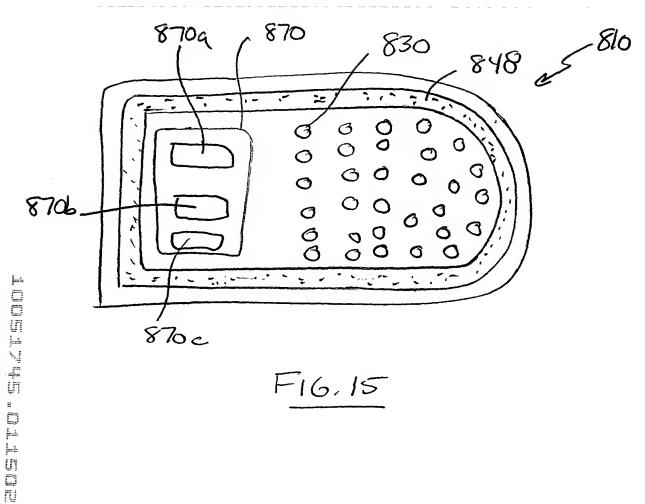
Title: MICRONEEDLE DEVICES AND METHODS OF MANUFACTURE

Applicant(s):

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